L Number	Hits	Search Text	DΒ	Time stamp
1	110509	wireless	USPAT;	2003/01/02
1 -			US-PGPUB;	15:52
1			EPO; JPO;	
			DERWENT;	
			IBM TDB	
	57474	non near2 contact	USPAT;	2003/01/02
2	3/4/4	Holl Hearz Contact	US-PGPUB;	15:52
				13.32
			EPO; JPO;	
			DERWENT;	
	1150024		IBM_TDB	2003/01/02
3	1150024	sensor	USPAT; US-PGPUB;	15:51
			EPO; JPO;	13.31
1				
			DERWENT;	
	000100		IBM_TDB	2002/01/02
4	239120	transducer	USPAT;	2003/01/02
			US-PGPUB;	15:51
			EPO; JPO;	
			DERWENT;	
-	1044100		IBM_TDB	2003/01/03
5	1244139	memory	USPAT;	2003/01/02
			US-PGPUB;	15:52
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	/
6	15195	transponder	USPAT;	2003/01/02
			US-PGPUB;	15:52
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
7	213731	antenna	USPAT;	2003/01/02
			US-PGPUB;	10:27
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
8	2391981		USPAT;	2003/01/02
		(transponder same antenna)	US-PGPUB;	10:28
			EPO; JPO;	
			DERWENT;	l
_			IBM_TDB	2222 (22 (22
9	47906	600/\$.ccls.	USPAT;	2003/01/02
			US-PGPUB;	10:28
			EPO; JPO;	
			DERWENT;	
1.0	2555	606/4	IBM_TDB	2002/01/02
10	35283	606/\$.ccls.	USPAT;	2003/01/02
			US-PGPUB;	10:28
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	0000 (01 (00
11	9479	602/\$.ccls.	USPAT;	2003/01/02
			US-PGPUB;	10:28
			EPO; JPO;	
			DERWENT;	
		504/4	IBM_TDB	2002/07/02
12	54023	604/\$.ccls.	USPAT;	2003/01/02
			US-PGPUB;	10:28
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
13	31663	128/\$.ccls.	USPAT;	2003/01/02
			US-PGPUB;	10:28
			EPO; JPO;	
			DERWENT;	Į l
L			IBM_TDB	

14					
15   27509   (sensor or transducer or memory or (transponder same antenna)) same (wireless or (non hearlz contact))   (sensor or transducer or memory or (transponder same antenna)) same (wireless or (non hearlz contact))   (sensor or transducer or memory or (transponder same antenna)) same (wireless or (non hearlz contact))   (sensor or transducer or memory or (transponder same antenna)) same (wireless or (non hearlz contact))   (sensor or transducer or memory or (transponder same antenna)) same (wireless or (non hearlz contact))   (sensor or transducer or memory or (transponder same antenna)) same (wireless or (non hearlz contact))   (sensor or transducer or memory or (transponder same antenna)) same (wireless or (non hearlz contact))   (sensor or transducer or memory or (transponder same antenna)) same (wireless or (non hearlz contact))   (sensor or transducer or memory or (transponder same antenna)) same (wireless or (sensor or contact))   (sensor or contact))   (sensor or contact)   (sensor	14	166981	wireless or (non near2 contact)	USPAT;	2003/01/02
15   27509   (sensor or transducer or memory or (transponder same antenna)) same (wireless or (non near2 contact))   10:29   2003/01/02   10:29   2003/01/02   10:29   2003/01/02   10:29   2003/01/02   10:29   2003/01/02   10:29   2003/01/02   10:29   2003/01/02   10:29   2003/01/02   10:29   2003/01/02   10:33   2003/01/02   10:33   2003/01/02   10:33   2003/01/02   10:33   2003/01/02   10:33   2003/01/02   10:33   2003/01/02   10:33   2003/01/02   10:33   2003/01/02   10:39   2003/01/02   10:29   2003/01/02   10:30   2003/01/02   10:30   2003/01/02   10:30   2003/01/02   10:30   2003/01/02   10:30   2003/01/02   10:30   2003/01/02   10:30   2003/01/02   2				US-PGPUB;	10:28
15   27509   (sensor or transducer or memory or (transponder same antenna)) same (wireless or (non nearl contact))   10:29				EPO; JPO;	
15				DERWENT;	
15				IBM TDB	
(transponder same antenna) same (wireless or (non near2 contact))   DEPOEDS   DEPOED	15	27509	(sensor or transducer or memory or		2003/01/02
Wireless or (non near2 contact)   EPO; JPO;   DERWENT; IBM TDB   USPAT;	13	2,303			
16				1	10.23
16			(wileless of (non hearz contact))	1	
16					
(transponder same antenna)) same (wireless or (non near2 contact)) and (600/s.ccls. or 604/s.ccls. or 106/s.ccls. or 1060/s.ccls. or 1060/s.				_	0000 (01 (00
(wireless or (non near2 contact)) and (600/s.ccls. or 606/s.ccls. or 606/s.ccls	16	908			
GOO/S.ccls. or 604/S.ccls. or   DERWENT:   IBM_TDB   2003/01/02   10:29   10			(transponder same antenna)) same	1	10:33
17   29265   elasticity near10 modulus   USPAT; USPGUB; EPO; JPO; DERMENT; IBM TDB   10:29					
129/4.ccls.)   elasticity near10 modulus   USPAT; US-pcpUB; EDG; JPG; DERWENT; IBM TDB USPAT; USPAP; USP					
17			602/\$.ccls. or 604/\$.ccls. or	IBM_TDB	
18   22662   elastic near10 modulus   US-pcpUB; EPO; JPO; DERWENT; IBM TDB US-PAT; US-PCPUB; EPO; JPO; DERWEN		İ	128/\$.ccls.)	1	
18   22662   elastic near10 modulus   US-pcpUB; EPC; JPC; DERWENT; IBM TDB USPAT; USP-pcpUB; EPC; JPC; DERWENT; IBM TDB USPAT; USPAP; USP	17	29265	elasticity near10 modulus	USPAT;	2003/01/02
18			-	US-PGPUB;	10:29
18				· ·	
18					-
18				i i	
19	10	22662	olastic mearin modulus		2003/01/02
19	10	22002	erastic Hearin Modulus		
19	1		•		10.29
19	}				
19					
S-PGPUB,   10:29   10:30   1					( (
20   263548   silicone   Silico	19	59406	heat near10 conductivity		
DERWENT; IBM TDB   USPAT; US-PCPUB; EPO; JPO; DERWENT; IBM TDB   U	•				10:29
20   263548   silicone     IBM_TDB   USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB   USPAT; U	Ì			EPO; JPO;	
20				DERWENT;	
10:29   10:30   10:29   10:29   10:29   10:29   10:30   10:29   10:29   10:30   10:29   10:30   10:29   10:30   10:29   10:30   10:29   10:30   10:29   10:30   10:29   10:30   10:29   10:30   10:29   10:30   10:29   10:30   10:3				IBM TDB	
10:29   10:2	20	263548	silicone	USPAT;	2003/01/02
21   340939   epoxy   EPO; JERWENT; IBM TDB   USPAT; USP		""		1	
21   340939   epoxy   DERWENT;   IBM TDB   USPĀT;   US-PGPUB;   EPO; JPO; DERWENT;   IBM TDB   USPĀT;					
21   340939   epoxy     IBM_TDB   USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB   USPAT; US-PGPUB; EPO; JPO; JPO; DERWENT; IBM_TDB   USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB   USPAT; US-PGPUB; EPO; JPO; JPO; JPO; JPO; JPO; JPO; JPO; J		ŀ			
21 340939 epoxy				t .	
US-PGPUB; EPO; JPO; DERWENT; IBM TDB	21	340030	oney.	· —	2003/01/02
22   1217   duroplastic   EPO; JPO; DERWENT; IBM TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; EPO; JPO; DERWENT; EPO; JPO; DERWENT; EPO; JPO; DERWENT;	21	340939	epoxy	1	
DERWENT; IBM TDB   USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB   U		1		)	10.29
18M TDB   USPAT;					
22				1	
10:29     10:29				_	0000 (01 (00
23   168709   cement   EPO; JPO; DERWENT; IBM TDB USPAT; US-PEPUB; EPO; JPO; DERWENT; EPO; JPO; D	22	1217	duroplastic	· · · · · ·	
DERWENT;   IBM TDB   USPAT;   US-PGPUB;   EPO; JPO;   DERWENT;				10:29	
168709   cement     IBM_TDB   USPAT;   US-PGPUB;   EPO; JPO;   DERWENT;   DERWENT;   US-PGPUB;   EPO; JPO;   DERWENT;   DERWENT;   EPO; JPO;   DERWEN					
23					
24   480995   ceramic   US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	-			IBM_TDB	
24   480995   ceramic   EPO; JPO; DERWENT; IBM_TDB   USPAT; US-PGPUB; EPO; JPO; DERWENT;	23	168709	cement	USPAT;	
24   480995   ceramic   DERWENT;   IBM_TDB   USPAT;   US-PGPUB;   EPO; JPO; DERWENT;   ISM_TDB   USPAT;   US-PGPUB;   EPO; JPO; DERWENT;				US-PGPUB;	10:30
24   480995				EPO; JPO;	
24   480995				DERWENT;	
24   480995   ceramic   USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; US-PGPUB; EPO; JPO; DERWENT; US-PGPUB; EPO; JPO; DERWENT; US-PGPUB; EPO; JPO; DERWENT; EPO; J					
US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; US-PGPUB; EPO; JPO; DERWENT; US-PGPUB; EPO; JPO; DERWENT; US-PGPUB; EPO; JPO; DERWENT;	24	480995	ceramic		2003/01/02
25 1113138 silicone or epoxy or duroplastic or cement or ceramic US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; US-PGPUB; EPO; JPO; DERWENT; US-PGPUB; EPO; JPO; DERWENT;		,		· ·	
DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;					
25					
25					
cement or ceramic  US-PGPUB; EPO; JPO; DERWENT; IBM_TDB US-PGPUB; EPO; JPO; DERWENT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB US-PGPUB; EPO; JPO; DERWENT; IBM_TDB US-PGPUB; EPO; JPO; DERWENT; IBM_TDB US-PGPUB; EPO; JPO; DERWENT; US-PGPUB; EPO; JPO; DERWENT; US-PGPUB; EPO; JPO; DERWENT; DERWENT;	25	1112122			2002/01/02
26 47443 (elasticity near10 modulus) or (elastic near10 modulus) or (elastic USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB  27 1059 ((elasticity near10 modulus) or (elastic near10 modulus)) and (heat near10 uspat;	43	1112128	1		1
26 47443 (elasticity near10 modulus) or (elastic near10 modulus) or (elastic USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB  27 1059 ((elasticity near10 modulus) or (elastic near10 modulus)) and (heat near10 USPAT; US-PGPUB; EPO; JPO; DERWENT; US-PGPUB; EPO; JPO; DERWENT; DERWENT;			cement or ceramic		10:30
26 47443 (elasticity near10 modulus) or (elastic near10 modulus) or (elastic USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB  27 1059 ((elasticity near10 modulus) or (elastic near10 modulus)) and (heat near10 USPAT; US-PGPUB; EPO; JPO; DERWENT; US-PGPUB; EPO; JPO; DERWENT;					1
26 47443 (elasticity near10 modulus) or (elastic near10 modulus)  27 1059 ((elasticity near10 modulus) or (elastic near10 modulus)) and (heat near10 tonductivity)  28 27 29 2003/01/02 10:30  29 2003/01/02 10:30  20 2003/01/02 10:30  20 20 3/01/02 10:30					
near10 modulus)  10:30  US-PGPUB; EPO; JPO; DERWENT; IBM_TDB  ((elasticity near10 modulus) or (elastic near10 modulus)) and (heat near10 USPAT; US-PGPUB; EPO; JPO; DERWENT;  conductivity)  US-PGPUB; EPO; JPO; DERWENT;					
near10 modulus)  10:30  US-PGPUB; EPO; JPO; DERWENT; IBM_TDB  ((elasticity near10 modulus) or (elastic near10 modulus)) and (heat near10 USPAT; US-PGPUB; EPO; JPO; DERWENT;  conductivity)  US-PGPUB; EPO; JPO; DERWENT;	26	47443		1	
27 1059 ((elasticity near10 modulus) or (elastic near10 modulus)) and (heat near10 USPAT; US-PGPUB; conductivity) EPO; JPO; DERWENT;				US-PGPUB;	10:30
27 1059 ((elasticity near10 modulus) or (elastic near10 modulus)) and (heat near10 USPAT; US-PGPUB; conductivity) EPO; JPO; DERWENT;				EPO; JPO;	
27 1059 ((elasticity near10 modulus) or (elastic near10 modulus)) and (heat near10 tonductivity)   IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;   DERWENT;   DERWENT;   DERWENT;				1	1
27 1059 ((elasticity near10 modulus) or (elastic USPAT; 2003/01/02 near10 modulus)) and (heat near10 USPAT; US-PGPUB; conductivity) EPO; JPO; DERWENT;				1	†
near10 modulus)) and (heat near10 US-PGPUB; 10:30 conductivity) EPO; JPO; DERWENT;	27	1050	((elasticity near10 modulus) or (elastic		2003/01/02
conductivity) EPO; JPO; DERWENT;	- '	1039			
DERWENT;					10.30
			Conductivity		
IBM TDB					
				TRW_LDB	<u>                                     </u>

				0000 (00 100
28	700	(((elasticity near10 modulus) or (elastic	USPAT;	2003/01/02
		near10 modulus)) and (heat near10	US-PGPUB;	10:30
		conductivity)) and (silicone or epoxy or	EPO; JPO;	
		duroplastic or cement or ceramic)	DERWENT;	
	1		IBM TDB	
29	0	((((elasticity near10 modulus) or	USPAT;	2003/01/02
23			US-PGPUB;	10:31
	1	(elastic near10 modulus)) and (heat		10.31
į į	Ì	near10 conductivity)) and (silicone or	EPO; JPO;	
		epoxy or duroplastic or cement or	DERWENT;	
!		ceramic)) and (((sensor or transducer or	IBM_TDB	
		memory or (transponder same antenna))		
		same (wireless or (non near2 contact)))		
		and (600/\$.ccls. or 606/\$.ccls. or		
		602/\$.ccls. or 604/\$.ccls. or		
		128/\$.ccls.))		
20	4		USPAT;	2003/01/02
30	4	((((elasticity near10 modulus) or	· ·	' '
		(elastic near10 modulus)) and (heat	US-PGPUB;	10:31
		near10 conductivity)) and (silicone or	EPO; JPO;	
		epoxy or duroplastic or cement or	DERWENT;	
		ceramic)) and ((sensor or transducer or	IBM_TDB	
		memory or (transponder same antenna))	_	
		same (wireless or (non near2 contact)))		
31	203	(((sensor or transducer or memory or	USPAT;	2003/01/02
	203	(transponder same antenna)) same	US-PGPUB;	10:33
	1	(wireless or (non near2 contact))) and	EPO; JPO;	-5.55
		(600/\$.ccls. or 606/\$.ccls. or	DERWENT;	
		602/\$.ccls. or 604/\$.ccls. or	IBM_TDB	
		128/\$.ccls.)) and (silicone or epoxy or		
	1	duroplastic or cement or ceramic)		
32	1	((((sensor or transducer or memory or	USPAT;	2003/01/02
		(transponder same antenna)) same	US-PGPUB;	10:34
		(wireless or (non near2 contact))) and	EPO; JPO;	
		(600/\$.ccls. or 606/\$.ccls. or	DERWENT;	
		602/\$.ccls. or 604/\$.ccls. or	IBM TDB	
1		128/\$.ccls.)) and (silicone or epoxy or	1011_100	
		duroplastic or cement or ceramic)) and		
		(elasticity near10 modulus)		
33	1	((((sensor or transducer or memory or	USPAT;	2003/01/02
	1	(transponder same antenna)) same	US-PGPUB;	10:35
		(wireless or (non near2 contact))) and	EPO; JPO;	
		(600/\$.ccls. or 606/\$.ccls. or	DERWENT;	
		602/\$.ccls. or 604/\$.ccls. or	IBM TDB	
		128/\$.ccls.)) and (silicone or epoxy or	_	
		duroplastic or cement or ceramic)) and		
		(elastic near10 modulus)		
34	8		USPAT;	2003/01/02
24	1 8			
		(transponder same antenna)) same	US-PGPUB;	10:36
		(wireless or (non near2 contact))) and	EPO; JPO;	
		(600/\$.ccls. or 606/\$.ccls. or	DERWENT;	
		602/\$.ccls. or 604/\$.ccls. or	IBM_TDB	]
		128/\$.ccls.)) and (silicone or epoxy or		
		duroplastic or cement or ceramic)) and		
		(heat near10 conductivity)		
71	287551	embedded	USPAT;	2003/01/02
, <del>, ,</del>	20,001	Califor C on the C M	US-PGPUB;	11:56
			EPO; JPO;	
	1		DERWENT;	
			IBM_TDB	
72	4033	embedded near3 sensor	USPAT;	2003/01/02
			US-PGPUB;	11:57
			EPO; JPO;	ļ ļ
			DERWENT;	
			IBM TDB	ļ
73	361545	float\$5	USPAT;	2003/01/02
,3	301343	110007		11:57
			US-PGPUB;	11.5/
			EPO; JPO;	
			DERWENT;	
I	1		IBM TDB	1

74	12	(embedded near3 sensor) same float\$5	USPAT; US-PGPUB;	2003/01/02 11:59
			EPO; JPO; DERWENT;	
			IBM_TDB	
75	267551	shock	USPAT; US-PGPUB;	2003/01/02 11:59
			EPO; JPO;	11.39
			DERWENT; IBM TDB	
76	1225683	load	USPAT;	2003/01/02
			US-PGPUB; EPO; JPO;	11:59
			DERWENT;	
78	314727	medical	IBM_TDB USPAT;	2003/01/02
	011/2/		US-PGPUB;	15:53
			EPO; JPO; DERWENT;	
			IBM_TDB	2002/01/02
79	7	((embedded near3 sensor) same (shock or load)) and medical	USPAT; US-PGPUB;	2003/01/02 12:00
			EPO; JPO; DERWENT;	
			IBM_TDB	
77	162	(embedded near3 sensor) same (shock or load)	USPAT; US-PGPUB;	2003/01/02 12:15
		10au)	EPO; JPO;	12.13
			DERWENT; IBM TDB	
141	176802	gauge	USPAT;	2003/01/02
			US-PGPUB; EPO; JPO;	15:52
			DERWENT;	
142	782235	detector	IBM_TDB USPAT;	2003/01/02
			US-PGPUB; EPO; JPO;	15:52
			DERWENT;	
143	943285	gauge or detector	IBM_TDB USPAT;	2003/01/02
110	7.0200	Jan 1	US-PGPUB;	15:33
			EPO; JPO; DERWENT;	
144	707016	anaged on analoged	IBM_TDB USPAT;	2003/01/02
144	/6/616	encas\$4 or enclos\$4	US-PGPUB;	15:54
			EPO; JPO; DERWENT;	
			IBM_TDB	
145	1041366	surround\$4	USPAT; US-PGPUB;	2003/01/02 15:55
			EPO; JPO;	
			DERWENT; IBM_TDB	
146	3030548	(sensor or transducer or memory or (transponder same antenna)) or gauge or	USPAT; US-PGPUB;	2003/01/02 15:34
		detector	EPO; JPO;	13.31
			DERWENT; IBM TDB	
147	318594	embed\$4	USPAT;	2003/01/02
			US-PGPUB; EPO; JPO;	15:54
			DERWENT;	
148	1057472	(encas\$4 or enclos\$4) or embed\$4	IBM_TDB USPAT;	2003/01/02
			US-PGPUB;	15:34
			EPO; JPO; DERWENT;	
			IBM TDB	1

	01455	((sensor or transducer or memory or	AT;	2003/01/02
149		(transponder same antenna)) or gauge or	US-PGPUB;	15:35
	1	detector) same ((encas\$4 or enclos\$4) or	EPO; JPO;	
		ambed\$4)	DERWENT; IBM TDB	
			USPAT;	2003/01/02
150		(Wireless of (Non hearz contact)) and	US-PGPUB;	15:37
	4	(transponder same antenna)) or gauge or	EPO; JPO;	
	ļ.,	detector) same ((encas\$4 or enclos\$4) or	DERWENT; IBM TDB	
		ambad54))	USPAT;	2003/01/02
151		///sensor or transducer or memory or	US-PGPUB;	15:35
		(transponder same antenna)) or gauge or	EPO; JPO; DERWENT;	
į		defector) Same (lencasys or chores,	IBM TDB	
150	1052	(/wireless or (non near2 contact)) and	USPAT;	2003/01/02
152	1052	///sonsor or transducer or memory or	US-PGPUB;	15:37
	1	(transponder same antenna)) or gauge or	EPO; JPO; DERWENT;	
		detector) same ((encas\$4 or enclos\$4) or embed\$4))) and (silicone or epoxy or	IBM_TDB	
	i i	duroplastic or cement or ceramic)		2002/01/02
153	201	modical and (((wireless or (non near2))	USPAT; US-PGPUB;	2003/01/02 15:38
		contact)) and (((sensor or transducer or memory or (transponder same antenna)) or	EPO; JPO;	20.00
		gauge or detector) same ((encas\$4 or	DERWENT;	
		encloss4) or embed\$4))) and (silicone or	IBM_TDB	
	\	epoxy or duroplastic or cement or		
	11600	ceramic)) sensor	USOCR	2003/01/02
154	11690	Selisor	*******	15:51
155	22679	transducer	USOCR	15:52
	15456	memory	USOCR	2003/01/02
156	16466	memory		15:52 2003/01/02
157	551	transponder	USOCR	15:52
	22.510		USOCR	2003/01/02
158	81619	gauge		15:52
159	52300	detector	USOCR	2003/01/02 15:52
	1057	wireless	USOCR	2003/01/02
160	4061	Wireless		15:52
161	4381	non near2 contact	USOCR	2003/01/02
			USOCR	2003/01/02
162	9628	medical		15:53
163	167577	sensor or transducer or memory or	USOCR	2003/01/02
100		transponder or gauge or detector	USOCR	2003/01/02
164	8428	wireless or (non near2 contact)		15:53
165	980	(sensor or transducer or memory or	USOCR	2003/01/02
103		transponder or gauge or detector) same		15:55
		(wireless or (non near2 contact)) ((sensor or transducer or memory or	USOCR	2003/01/02
166	8	transponder or gauge or detector) same	}	15:53
	1	(wireless or (non near2 contact))) and		
		medical	USOCR	2003/01/02
167	78264	embed\$4		15:54
168	359340	encas\$4 or enclos\$4	USOCR	2003/01/02
			USOCR	2003/01/02
169	408739	surround\$4		15:55
170	651068	(encas\$4 or enclos\$4) or surround\$4	USOCR	2003/01/02
170	031000	1	USOCR	15:55 2003/01/02
171	254	((encas\$4 or enclos\$4) or surround\$4) and ((sensor or transducer or memory or	USOCK	15:55
	1	transponder or gauge or detector) same		
1	1	(wireless or (non near2 contact)))		Į.

Search History 1/2/03 4:04:40 PM Page 5